SLN-VIZNLC-IOT-GSG

SLN-VIZNLC-IOT Getting Started Guide

Rev. 0 — 10 March 2023 **User guide**

Document information

Information	Content
Keywords	SLN-VIZNLC-IOT-GSG, Smart Lock, IoT
Abstract	This guide walks you through the process of getting up and running with your SLN-VIZNLC-IOT board

1 Plug it in

Welcome to the SLN-VIZNLC-IOT Getting Started Guide.

This guide walks you through the process of getting up and running with your SLN-VIZNLC-IOT board. This guide takes you through the steps of unboxing your kit, running the out-of-box smart lock demo application, as well as downloading, modifying, and debugging the firmware source code for your kit.

Before we begin, make sure to check the box your kit came in for any marks or other damages, and should you find anything, be sure to report it to your local NXP representative.

2 Smart Lock

2.1 Unbox

The box your kit arrives in should contain a few different things, including:

- A packing list paper
- Fully assembled VIZNLC kit
- USB-A > USB-C Cable (x1)
- Jumpers (x2)

Figure 1. Items inside the box

2.2 Power on

Before we begin, put a jumper on J3 (pin 2 and 3 on the left side) as shown in the yellow highlighted box in Figure 35. Then remove the protective film from the RGB and IR camera as shown in Figure 2. This protective film is used to protect the lens of each camera during transport. However, failure to remove may cause the image capture not to work correctly.

Figure 2. Protective film covering the two cameras: RGB and IR

To get started, follow the steps below:

1. Take the USB-A > USB-C cable provided inside the kit. Plug the USB-A end into USB port on your computer and the USB-C end into the USB port of the kit. The USB connector of the kit supplies power to the board and supports data transfer capabilities for Mass Storage Device (MSD) programming and virtual serial port communication.

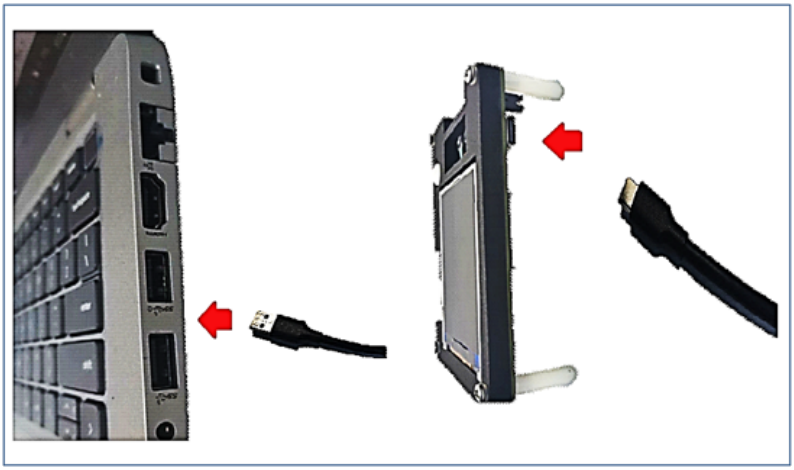

Figure 3. Power on the SLN-VIZNLC-IOT kit

2. Once the application is ready, your computer detects a new USB COM device, and automatically installs the required drivers. A message confirms when the installation is completed.
3. After powering on, the onboard TFT screen streams video directly from the RGB camera alongside a GUI overlay, providing information such as:
   - Locked/Unlocked status whether a face is recognized
   - Current App Type (Smart Lock/Access)
   - ON/OFF status of Wi-Fi and Bluetooth LE
   - Number of registered users

Figure 4. The screen with video preview

2.3 Register and recognize a face

Let us get started with a demonstration of the out-of-box features of this application.

To use the recognition feature of the SLN-VIZNLC-IOT, a face must be registered in the local face database of the kit. To begin registering a new face, press the **Manual Registration button (SW4)** on the kit.

Figure 5. Manual Registration button (SW4)

Once pressed, a message indicating registration is taking place pops up at the top of the screen. The speaker plays an audio message confirming that the registration has started.

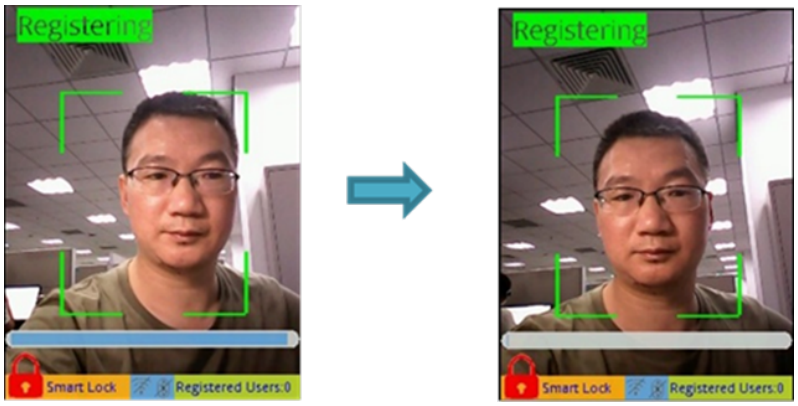

Figure 6. Registering screen

Figure 6 shows that while registration is taking place, the GUI displays:

- A “Registering” message
- Face alignment guidelines
- A countdown timer bar

The guidelines help you align your face correctly during registration, and the countdown timer bar indicates how much longer it takes until the registration process times out and fails.

Figure 7. Registration Timeout

As an additional measure to help with registering your face, the kit even plays a warning audio prompt if too much of the side of your face is exposed during the registration process, saying “Look at Camera”. The kit plays this warning audio until your face is properly pointed toward the camera.

Should your face fails to register, simply press the **SW4** button again to retry.

Once your face is successfully registered, the kit displays the message "Registration Successful", and a unique identifier is assigned to your face. The number of registered users is also updated automatically.

Figure 8. Registration Successful

Once registered, the kit displays the message “Recognition Successful” and plays a corresponding audio file when a recognized face is detected.

Figure 9. Recognition Successful

2.4 Liveness detection and anti-spoofing

The Liveness detection and anti-spoofing features of the SLN-VIZNLC-IOT are switched ON by default. Therefore, enabling the system to distinguish between your actual face and a printout or phone display image of your face.

This feature helps to defend against some of the most frequent face recognition "spoof" attacks.

One such spoof attack is when a malicious actor uses a picture of someone to gain access to their face-protected materials. The malicious actor does this spoof by requiring an actual face of the user to unlock the system rather than simply a picture of their face.

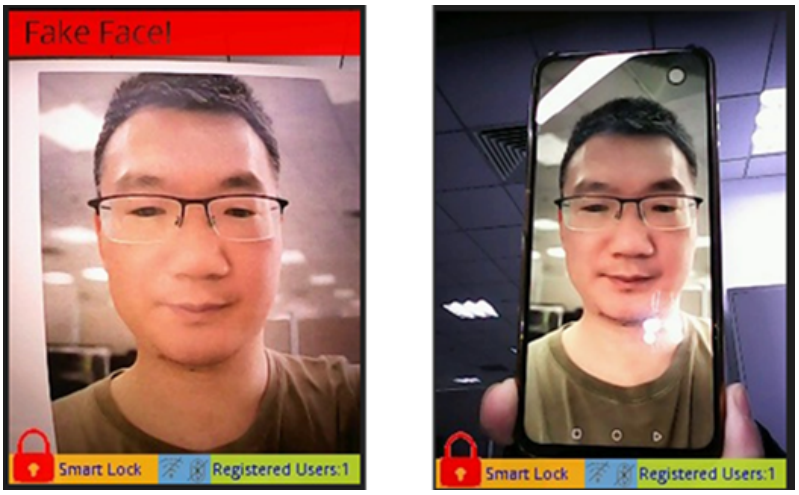

Figure 10. Printed picture and phone display spoof attack

As shown in Figure 10 using a phone display or a printed picture of a face does not trigger the “Recognition Successful” message.

2.5 Connect to serial CLI

The Smart Lock software installed by default on the SLN-VIZNLC-IOT kit provides a convenient serial-based CLI. This CLI is used to retrieve useful runtime data and configure various application settings. Connecting to the serial-based CLI of the kit can be done using a serial terminal emulator program like PuTTY or Tera Term.

Before we begin, make sure that you have a serial terminal emulator like PuTTY or Tera Term installed on your computer.

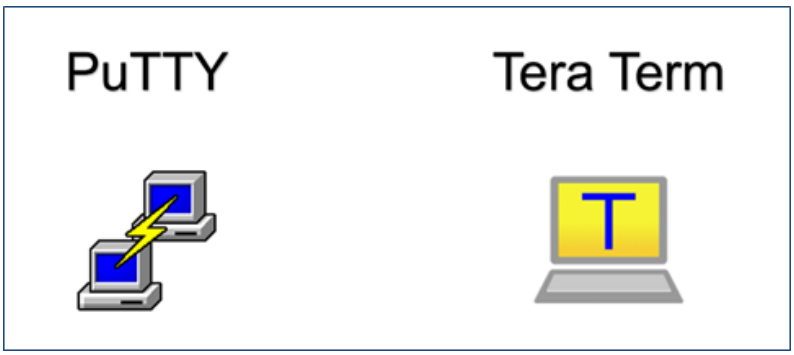

Figure 11. PuTTY and Tera Term

Note: *If you are using a Windows machine, we recommend Tera Term for its ability to discover connected COM devices automatically. Additionally, if there is a disconnect, Tera Term reconnects to a device.*

Establish a serial connection with your device by entering the serial settings as shown in Figure 12. Ensure to replace the COM port setting with the COM port associated with your kit.

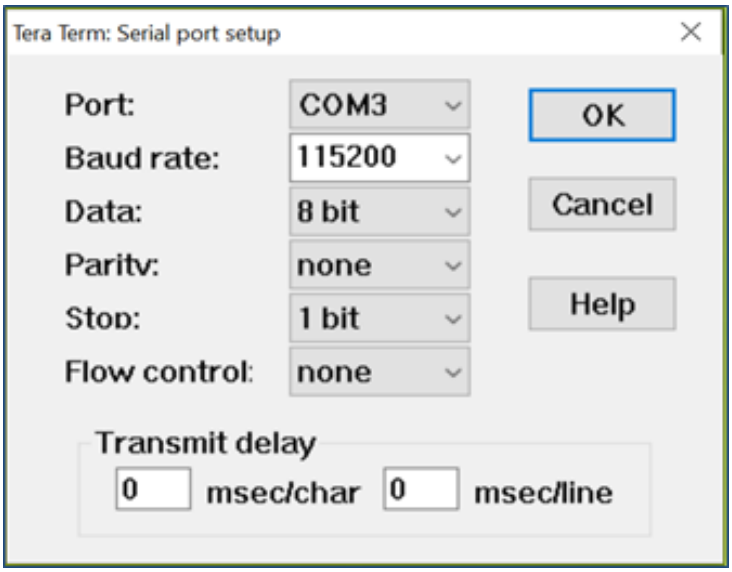

Figure 12. Serial port setup

Once connected, a blank terminal screen appears that echoes back any characters that you type. Typing the `help` command prints a list of all available commands and a brief description of their functionalities.

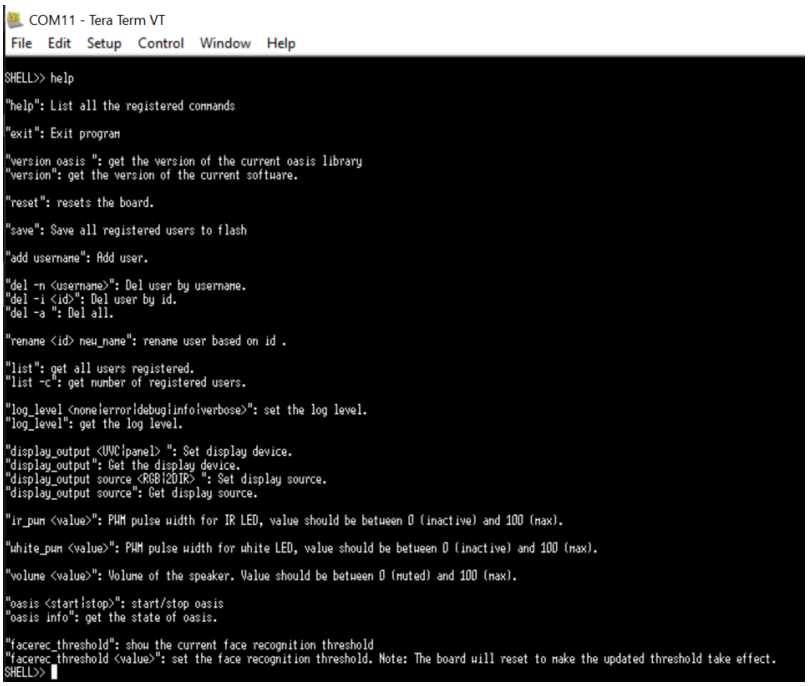

Figure 13. Help menu

3 Build and run

3.1 Getting MCUXpresso IDE

The MCUXpresso IDE brings developers an easy-to-use eclipse-based development environment for NXP MCUs based on Arm Cortex-M cores, including its general-purpose crossover and wireless-enabled MCUs.

The MCUXpresso IDE offers advanced editing, compiling, and debugging features. It also offers MCU-specific debugging views, code trace and profiling, multicore debugging, and integrated configuration tools.

To download MCUXpresso IDE, follow the steps below:

1. Go to MCUXpresso IDE homepage and click the **Downloads** button.

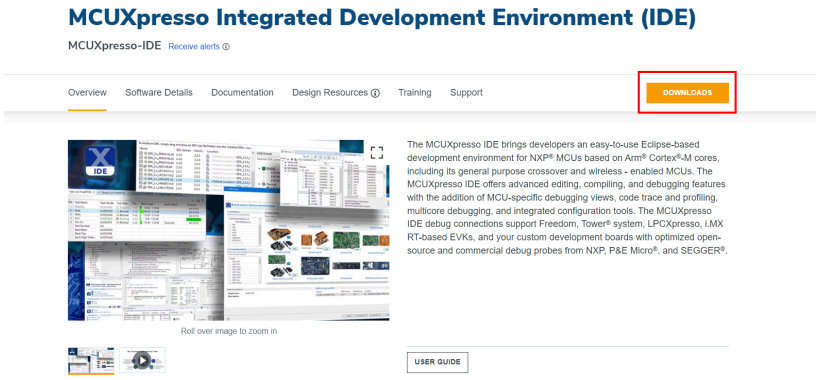

Figure 14. MCUXpresso IDE homepage

2. The **Downloads** page appears. Next, click the **Download** button.

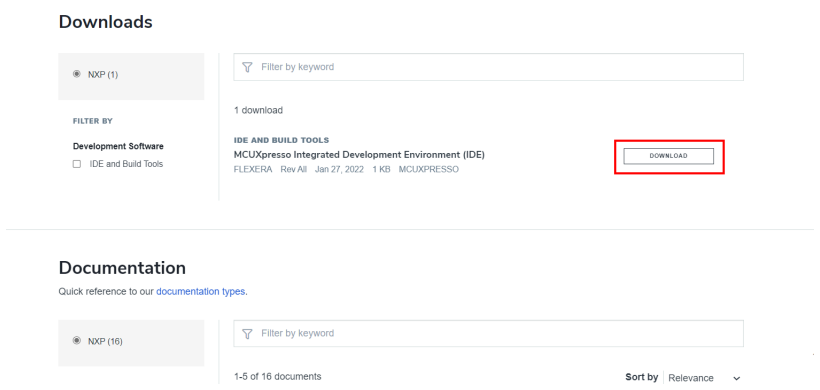

Figure 15. Downloads page

3. The **Sign In** page appears. Login with your credentials.

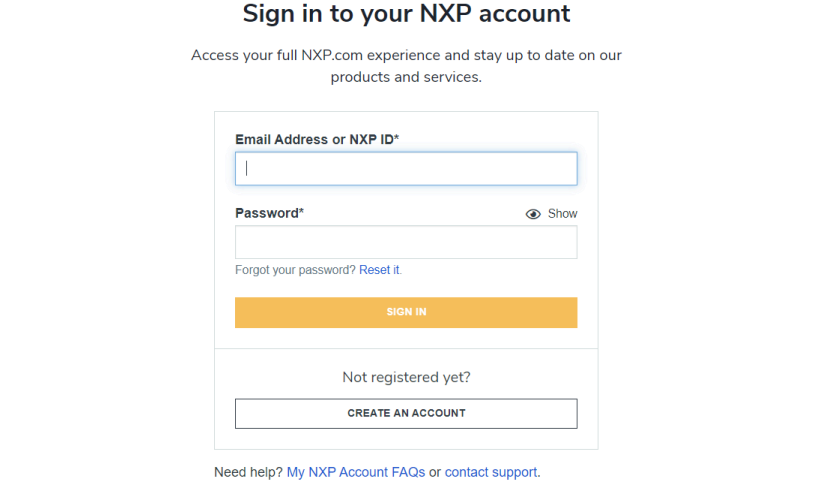

Figure 16. Sign In page

4. Once you have signed in, select **Version 11.6.1** or newer from the list.

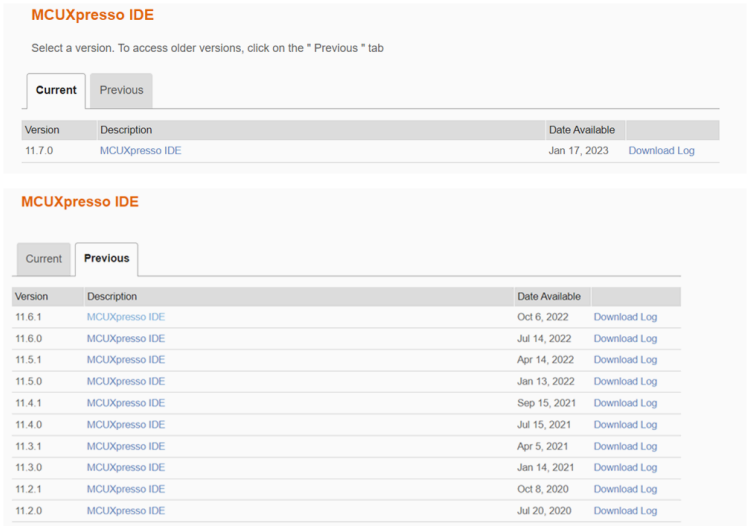

Figure 17. Select Version page

5. The **Software Terms and Conditions** page appears. Read the conditions and click the **I Agree** button.

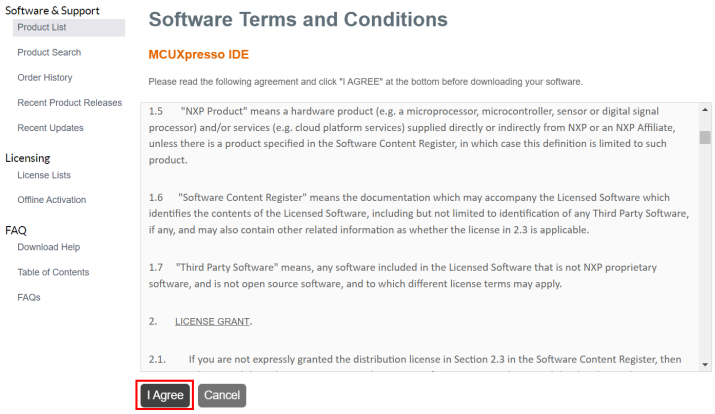

Figure 18. Software terms and conditions page

6. The **Product Download** page appears from where you can download the MCUXpresso IDE. Download the appropriate version for your system.

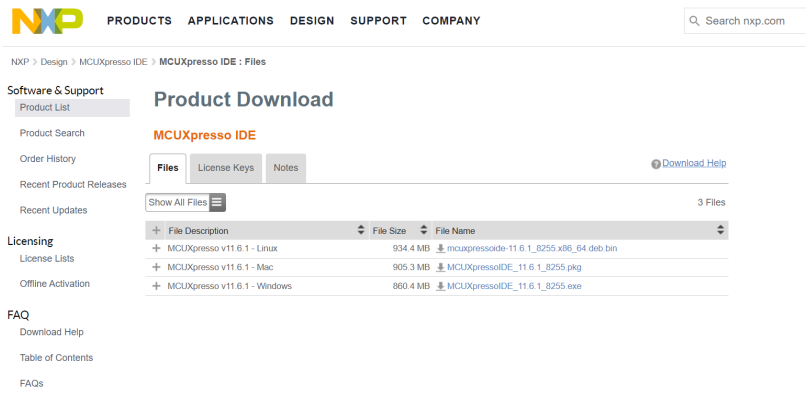

Figure 19. Product Download page

7. Open the downloaded application and follow the instructions found in the installer.

3.2 Installing the SDK

MCUXpresso SDK is a comprehensive software enablement package designed to simplify and accelerate application development with NXP microcontrollers based on Arm Cortex-M cores. The MCUXpresso SDK includes production-grade software with integrated RTOS (optional), stacks and middleware, reference software, and more. It is available in custom downloads based on user selections of MCU, evaluation board, and optional software components.

Before building the SLN-VIZNLC-IOT SDK example projects, the target SDKs (EVK-MIMXRT1060 and K32W061DK6) must be imported into MCUXpresso IDE. However, no need to import LPC845 as it is already preinstalled in the IDE.

To install MCUXpresso SDK, follow the steps below:

1. Launch the MCUXpresso SDK. The **MCUXpresso SDK Builder** welcome screen appears when the application is launched, as shown in Figure 20.

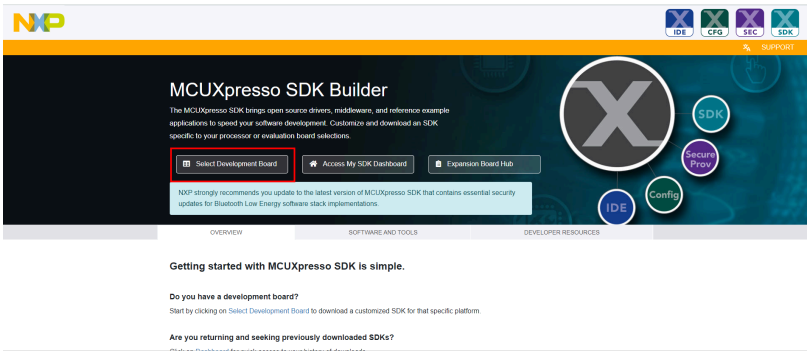

Figure 20. SDK Builder welcome screen

2. Click **Select Development Board**. After signing in, **Select Development Board** page appears.

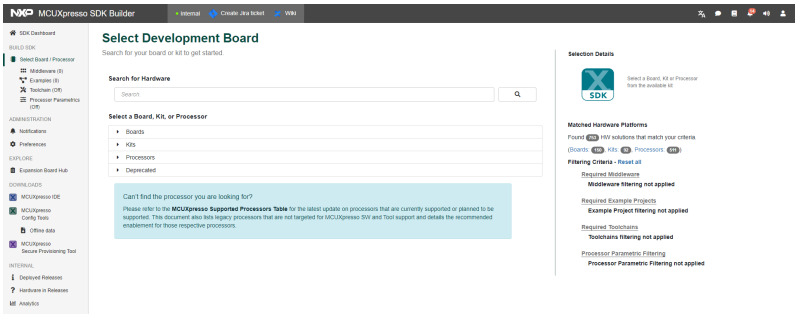

Figure 21. Select Development Board page

3. Search **1060** and select **EVK-MIMXRT1060** board. Then click **Build MCUXpresso SDK V2.12.1**.

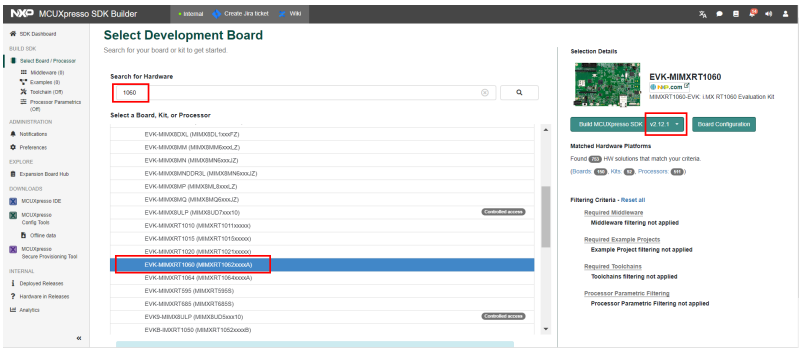

Figure 22. Select EVK-MIMXRT1060 SDK

4. To build SDK, select your **Host OS** and **Toolchain / IDE**, and all other necessary SDK components. Then click **Download SDK** button.

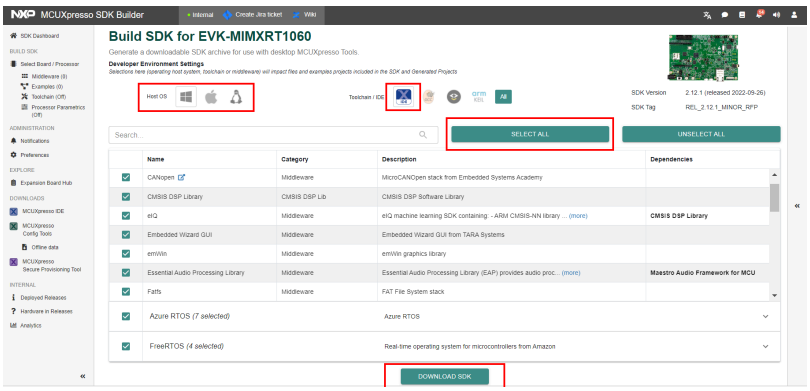

Figure 23. Build SDK and download

5. Dashboard page shows the built SDK. Click **Download** to download the SDK archive to your PC.

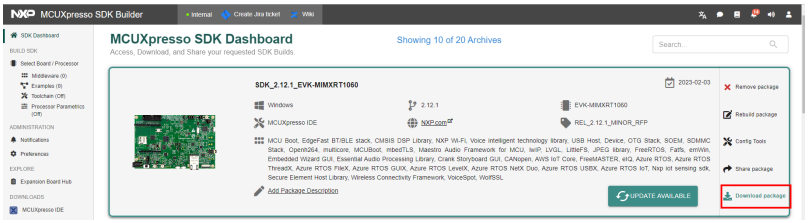

Figure 24. Downloading SDK archive

6. To install, drag and drop the SDK archive file to the IDE **Installed SDKs** view.

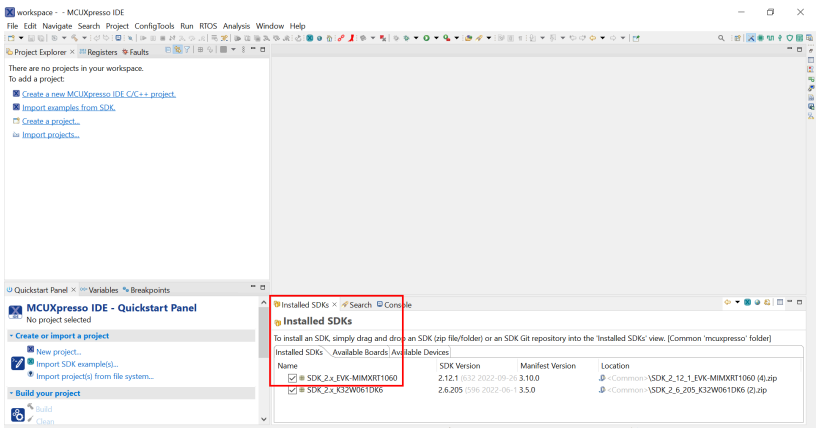

Figure 25. Install SDK

7. Download and install K32W061DK6 SDK V2.6.205 in the same way.

3.3 Downloading SLN-VIZNLC-IOT projects

The SLN-VIZNLC-IOT out-of-box projects are published under the NXP GitHub page. You can either clone the repository using Git or download a zip folder containing the source code from mcu-viznlc.

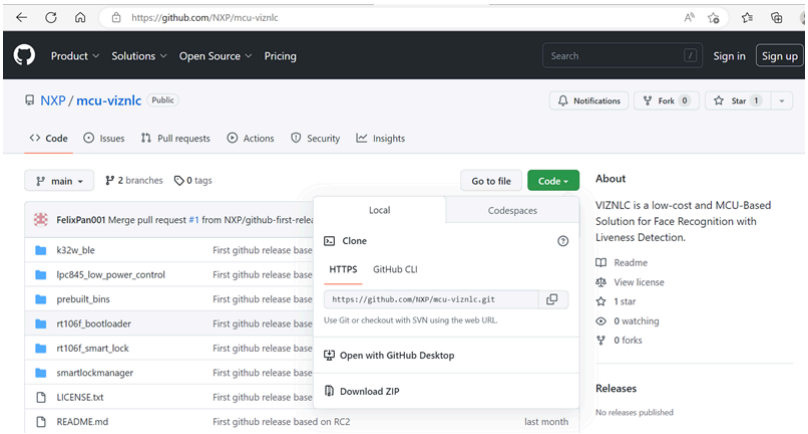

Figure 26. SLN-VIZNLC-IOT GitHub repository

Note: *If downloading a zipped archive, ensure to unzip this folder before proceeding to the next step.*

3.4 Importing SLN-VIZNLC-IOT projects

To import the projects we downloaded into the IDE, follow the steps below:

1. Click **Import project(s) from file system...**, then **Browse** your project path where you unzipped the `sln_viznlc_iot` source code, and click **Next**.

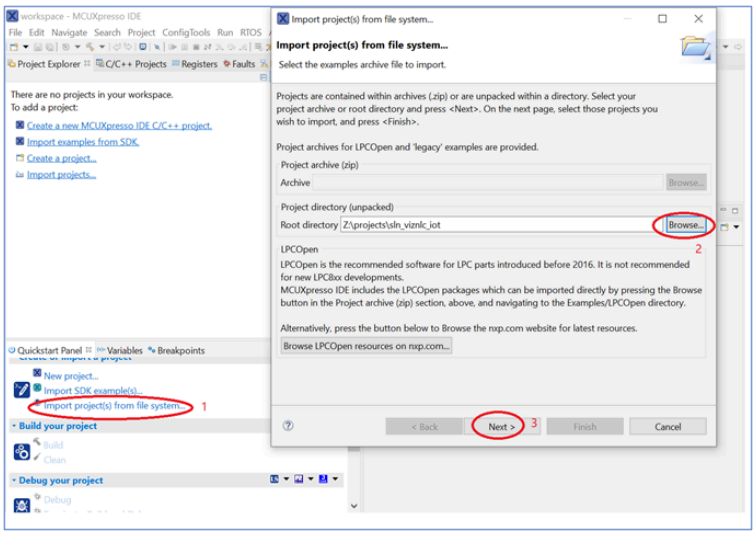

Figure 27. Import project(s) from file system

2. Import the files specified in Figure 28 from the displayed screen.

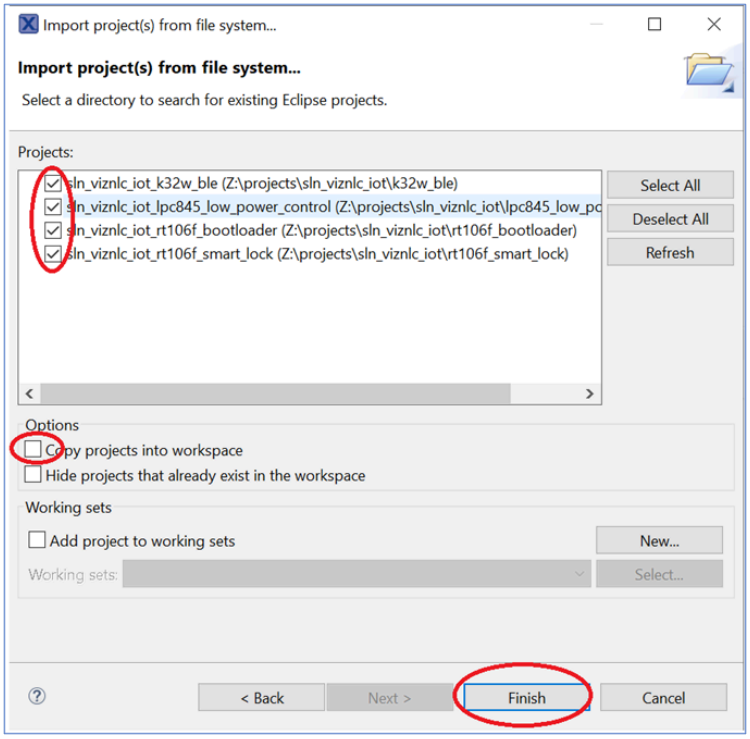

Figure 28. Import project(s) from file system

3. Once successfully imported, you should see projects open in the **Project Explorer** pane on the left side of the IDE.

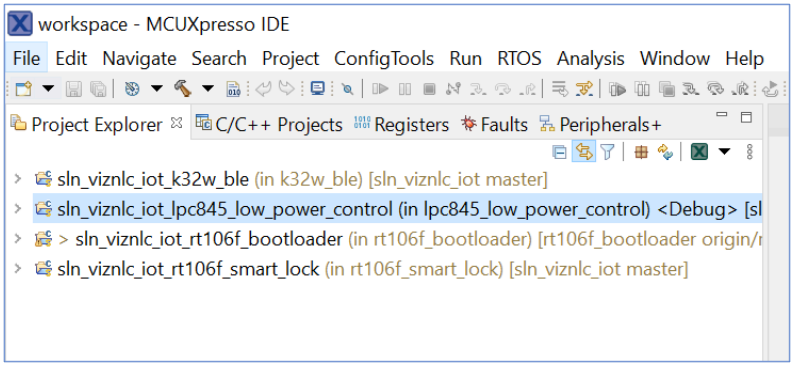

Figure 29. SLN-VIZNLC-IOT projects

3.5 Building the SLN-VIZNLC-IOT projects

The SLN-VIZNLC-IOT SDK allows you to build the smart lock application directly. The application is made up of four subprojects:

- The `lpc845_low_power_control` project manages the power control of the system. LPC845 works as the host MCU. PIR sensor activates the host MCU and powers the RT106F part.
- The `k32w_ble` project implements the feature of Bluetooth LE module (UART over Bluetooth LE).
- The `rt106f_bootloader` and `rt106f_smart_lock projects` are the out-of-box applications that we used earlier to demonstrate the SLN-VIZNLC-IOT face recognition capabilities. The bootloader manages to jump into the smart lock application.

These above applications are flashed onto your SLN-VIZNLC-IOT kit by default.

In the **Project Explorer** pane, select the project file and navigate to the **QuickStart Panel**. To start the compilation and linking of this application, click the **Build** option.

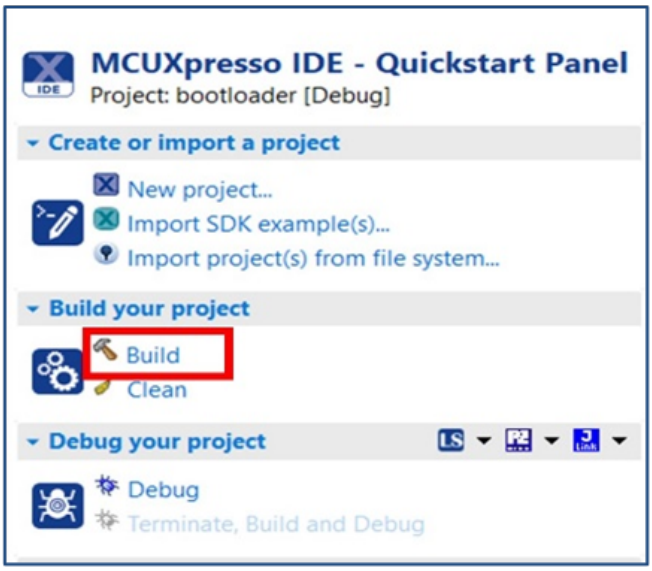

Figure 30. How to build

Building may take a few minutes to complete, but do not worry, as it is normal for applications of this size. Once finished, a message as shown in Figure 31 appears at the bottom of the IDE. Consider `rt106f_smart_lock` project as an example.

```
Building target: sln_viznlc_iot_rt106f_smart_lock.axf
Invoking: MCU C++ Linker
arm-none-eabi-c++ -nostdlib -L"Z:\projects\sln_viznlc_iot\rt106f_smart_lock\libs\oasis_2d" -L"Z:\pro
Memory region         Used Size  Region Size  %age Used
     BOARD_FLASH:     4025876 B         8 MB     47.99%
     BOARD_SDRAM:    10879844 B        13 MB     79.81%
    SRAM_DTC_cm7:       14100 B       256 KB      5.38%
    SRAM_ITC_cm7:        5444 B       256 KB      2.08%
   NCACHE_REGION:     3078312 B         3 MB     97.86%
SRAM_OCRAM_CACHED:          0 GB       256 KB      0.00%
SRAM_OCRAM_NCACHED:       38400 B       256 KB     14.65%
Finished building target: sln_viznlc_iot_rt106f_smart_lock.axf

Performing post-build steps
arm-none-eabi-size "sln_viznlc_iot_rt106f_smart_lock.axf"; # arm-none-eabi-objcopy -v -O binary "sln
   text    data     bss     dec     hex filename
4019612    6264 14004352    18030228    1131e94 sln_viznlc_iot_rt106f_smart_lock.axf
```

Figure 31. Build message

3.6 Flashing and debugging SLN-VIZNLC-IOT projects

With the SLN-VIZNLC-IOT application project compiled, it is now time to program associated binaries of this project into flash.

Flashing and debugging the SLN-VIZNLC-IOT kit requires a SEGGER J-Link with a 9-pin Cortex-M adapter and V7.60d or newer version of the J-Link Software and Documentation Pack. This new version of J-Link can be found on the SEGGER website.

Note: *There is a problem to program/debug RT106F using the default J-Link V7.70d in MCUXpresso IDE V11.6.1. J-Link software must be updated, and J-link software V7.60d has been verified.*

Figure 32. J-Link 9-pin adapter

Note: *The SLN-VIZNLC-IOT kit has one SWD interface connector (J2), which supports programming and debugging the RT106F, LPC845, and K32W061 via a SEGGER J-Link debug probe. To select which MCU to program/debug, the J4, J5, and J6 connectors, each must be set to the position indicated in Figure 33.*

Programming	J4&J5&J6	Layout Position
LPC845	1-2(Default)	
RT106F	2-3	
K32W061	2-4	

Figure 33. Switch debug interface

To flash the kit, follow the steps below:

1. Select the programming MCU on J4, J5, and J6 connectors.
2. Attach your J-Link debug probe into the J2 header as shown in Figure 34 and connect your J-Link to your computer via USB.

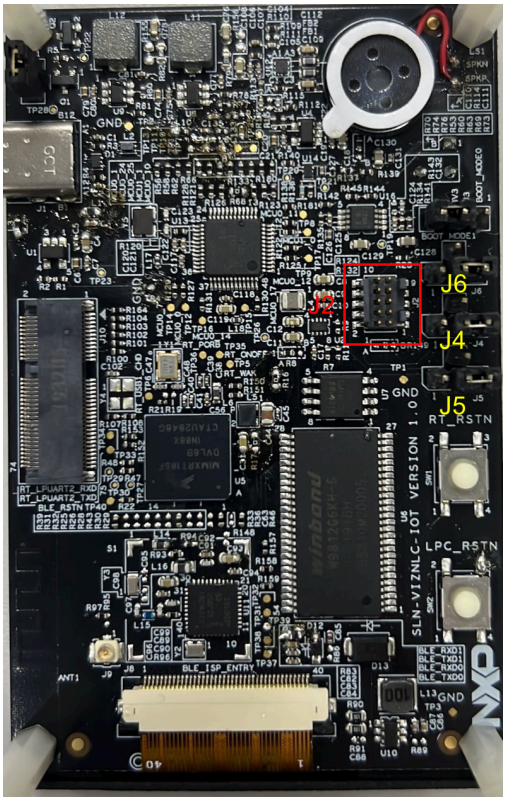

Figure 34. Attach J-Link debugger

3. Next, provide power to the kit by plugging a USB-C cable into the USB-C port of the kit and plug the other end into your laptop/PC.

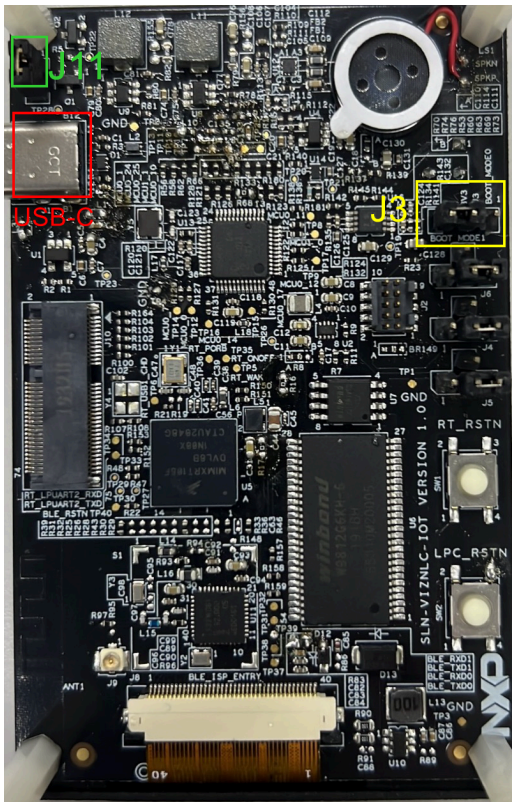

Figure 35. Power on SLN-VIZNLC-IOT kit

Note: *LPC845 controls the power supply of RT106F and K32W061. Therefore, during the debug stage, we can bypass it by connecting J11 jumper as shown in the green highlighted box in Figure 35.*

4. Select the MCU-related project in the **Project Explorer** pane. Consider `lpc845_low_power_control` as an example below.
5. To start the process of loading the binary into flash and begin debugging, choose the **Debug** option in the **QuickStart Panel**.

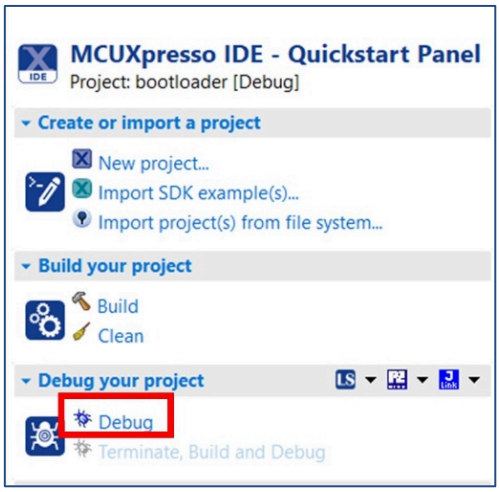

Figure 36. Debug your project

6. Select the J-Link probe that is connected to your kit and click the **OK** button. Flashing tool is launched.

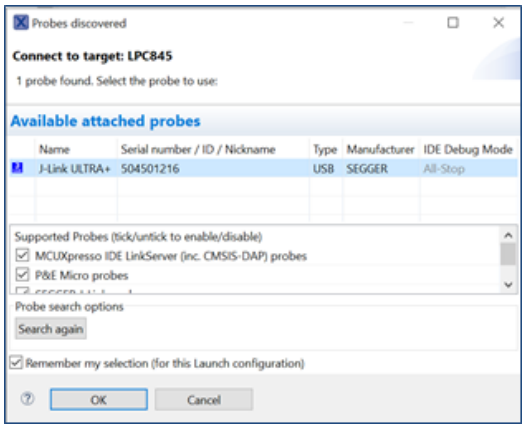

Figure 37. Probes discovered

7. Now, proceed to flash the binary associated with the currently selected project.

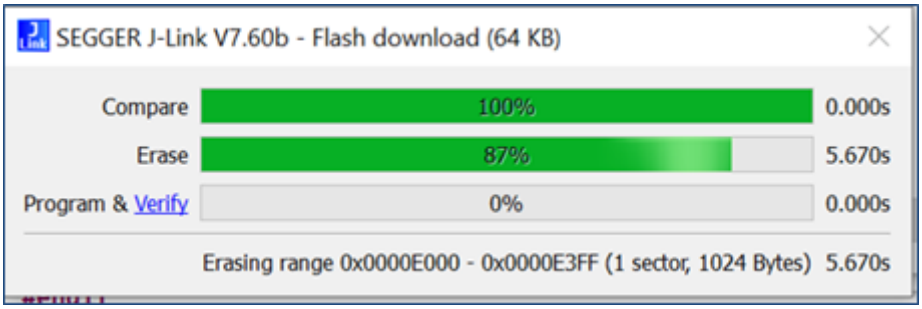

Figure 38. Flash downloading

8. After successfully debugging the application, the program breaks at the project main to start the **GDB** debug process.

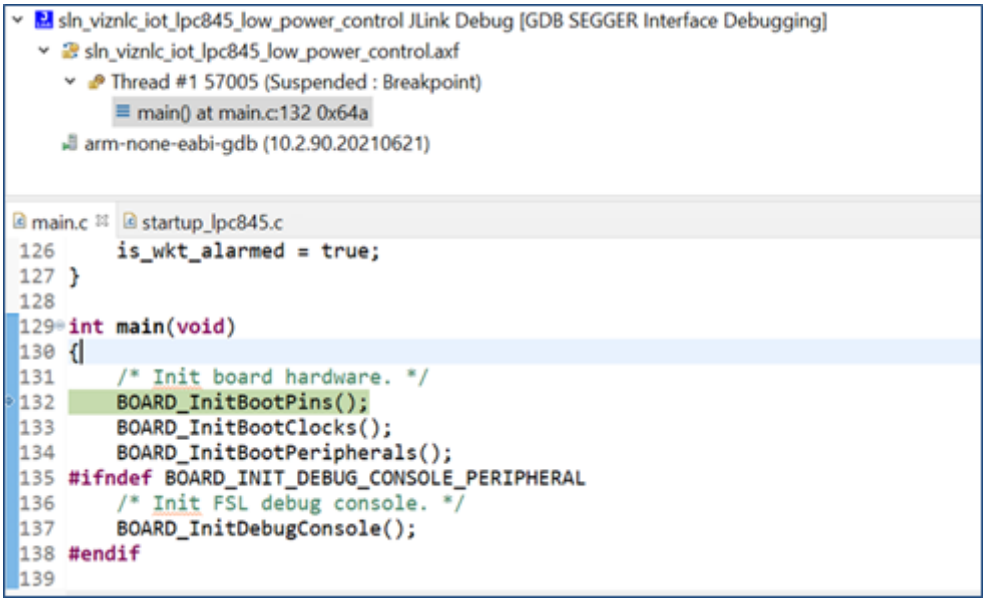

Figure 39. Start to debug project

9. To suspend the debug session, click the **pause/play** button on the top of the screen.

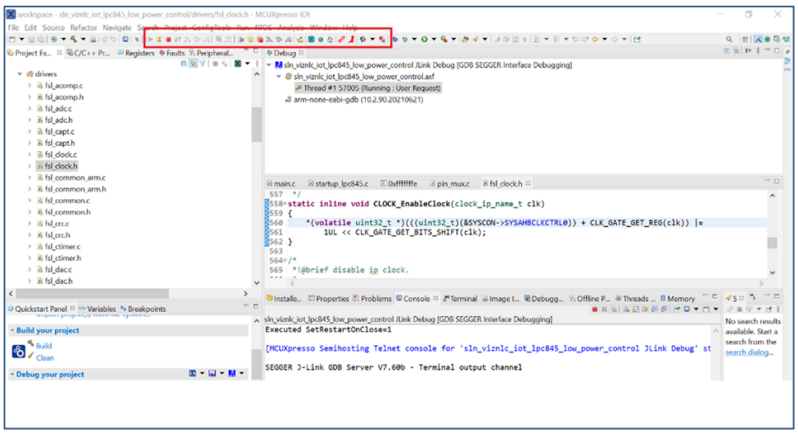

Figure 40. Debugging project

Note: *If you want to debug* `rt106f_smart_lock` *project, ensure that you have flashed the bootloader.*

3.7 Additional resources

If you have made it to this section, you have successfully finished the SLN-VIZNLC-IOT getting started experience.

For a comprehensive understanding of all the Out-of-Box Experience (OoBE) features, including the additional demo applications that come flashed with the kit, see *SLN-VIZNLC-IOT User Guide*.

To start building your own applications and learn more about the software architecture, available developer tools, and more, head over to the *SLN-VIZNLC-IOT Software Developer Guide*.

4 Acronyms

Table 1 lists the acronyms used in this document.

Table 1. Acronyms

Acronym	Definition
TFT	Thin Film Transistor
HAL	Hardware Abstraction Layer
OoBE	Out-of-Box Experience
MSD	Mass Storage Device
VIZNLC	Vision Low Cost
FW	Firmware
SW	Software
HW	Hardware
PIR	Passive InfraRed
IR	InfraRed
GUI	Graphical User Interface

5 Revision history

The Table 2 summarizes the changes done to this document since the initial release.

Table 2. Revision history

Revision history	Date	Substantive changes
0	10 March 2023	Initial release

6 Legal information

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Contents

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